

DCR1800F18

Phase Control Thyristor

DS6067-2 June 2019 (LN38848)

FEATURES

Double Side Cooling

APPLICATIONS

High Surge Capability

High Power Drives

Static Switches

VOLTAGE RATINGS

Part and Ordering

Number

DCR1800F18

DCR1800F16

DCR1800F14

DCR1800F12

High Voltage Power Supplies

Repetitive Peak

Voltages

 V_{DRM} and V_{RRM} v

1800

1600

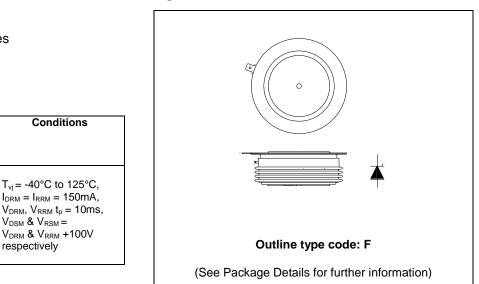
1400

1200

KEY PARAMETERS

V _{DRM}	1800 V
I _{T(AV)}	1800 A
I _{TSM}	32000 A
dV/dt*	1000 V/µs
dl/dt	200 A/µs

* Higher dV/dt selections available



Lower voltage grades available.

ORDERING INFORMATION

When ordering, select the required part number shown in the Voltage Ratings selection table.

V_{DSM} & V_{RSM} =

respectively

For example:

DCR1800F18

Note: Please use the complete part number when ordering and quote this number in any future correspondence relating to your order.

Fig. 1 Package outline



CURRENT RATINGS

T_{case} = 60°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
Double Si	de Cooled			
I _{T(AV)}	Mean on-state current	Half wave resistive load	1800	А
I _{T(RMS)}	RMS value	-	2820	А
Ι _Τ	Continuous (direct) on-state current	-	2550	А

SURGE RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
I _{TSM}	Surge (non-repetitive) on-state current	10ms half sine, $T_{case} = 125^{\circ}C$	32.0	kA
l ² t	I ² t for fusing	V _R = 0	5.12	MA ² s

THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Conditions	5	Min.	Max.	Units
R _{th(j-c)}	Thermal resistance – junction to case	Double side cooled	DC	-	0.02	°C/W
R _{th(c-h)}	Thermal resistance – case to heatsink	Double side cooled	DC	-	0.005	°C/W
T _{vj}	Virtual junction temperature	Blocking V _{DRM} / _{VRRM}		-	125	°C
T _{stg}	Storage temperature range			-40	140	°C
Fm	Clamping force			18	26	kN

DYNAMIC CHARACTERISTICS

Symbol	Parameter	Test Conditio	ns	Min.	Max.	Units
I _{RRM} /I _{DRM}	Peak reverse and off-state current	At V _{RRM} /V _{DRM} , T _{case} = 125°C		-	150	mA
dV/dt	Max. linear rate of rise of off-state voltage	To 67% V _{DRM} , T _j = 125°C, gate open		1000	-	V/µs
dl/dt	Rate of rise of on-state current	From 67% V _{DRM} to 2000A	Repetitive 50Hz	-	200	A/µs
		Gate source 30V, 10Ω ,	Non-repetitive	-	1000	A/µs
		$t_r < 0.5 \mu s, T_j = 125^{\circ}C$				
VT	On-state voltage	I _T = 2000A, T _{case} = 125°C			1.20	V
V _{T(TO)}	Threshold voltage – Low level	T _{case} = 125°C		-	0.84	V
r _T	On-state slope resistance – Low level	T _{case} = 125°C		-	0.18	mΩ
t _{gd}	Delay time	$V_D = 67\% V_{DRM}$, gate source	30V, 10Ω	-	3.0	μs
		$t_r=0.5\mu s, T_j=25^\circ C$				
tq	Turn-off time	$T_j = 125^{\circ}C, V_R = 100V, dl/dt$	= 10A/µs,	-	250	μs
		$dV_{DR}/dt = 20V/\mu s$ linear to 67	7% V _{DRM}			
Qs	Stored charge	$I_T = 2000A$, tp = 1000us,T _j = 125°C, dl/dt =10A/µs,		-	2500	μC
I _{RR}	Reverse recovery current			-	150	А
١L	Latching current	T _j = 25°C,		-	1	А
I _H	Holding current	$T_j = 25^{\circ}C,$		-	200	mA

GATE TRIGGER CHARACTERISTICS AND RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
V _{GT}	Gate trigger voltage	$V_{DRM} = 5V, T_{case} = 25^{\circ}C$	3	V
V_{GD}	Gate non-trigger voltage	At 40% V _{DRM} , T _{case} = 125°C	0.3	V
I _{GT}	Gate trigger current	$V_{DRM} = 5V, T_{case} = 25^{\circ}C$	300	mA
I _{GD}	Gate non-trigger current	At 40% V _{DRM} , T _{case} = 125°C	20	mA

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CURVES

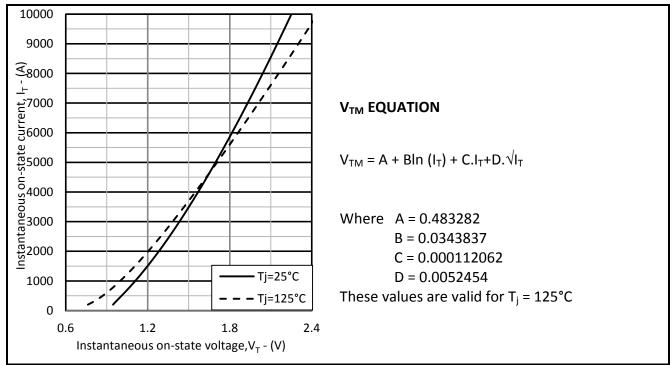


Fig.2 Maximum & minimum on-state characteristics

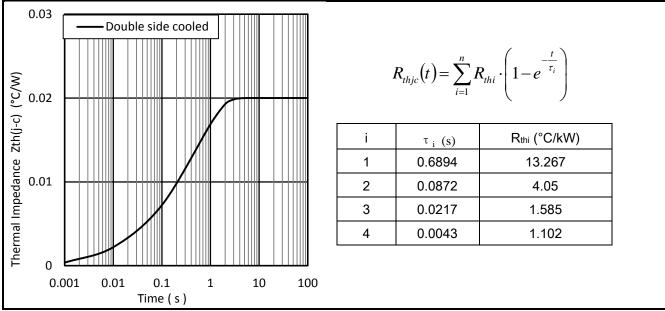
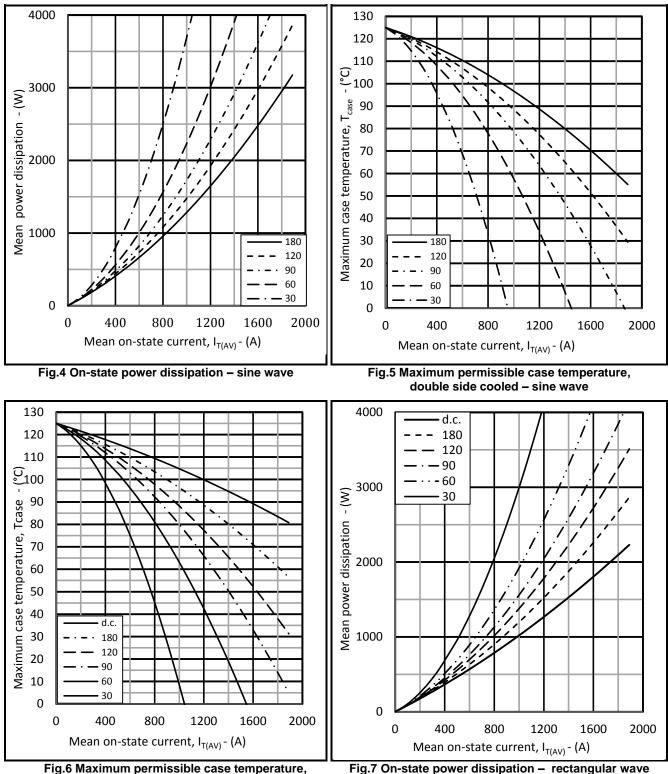


Fig.3 Maximum (limit) transient thermal impedance - junction to case (°C/W)





double side cooled - rectangular wave





DCR1800F18

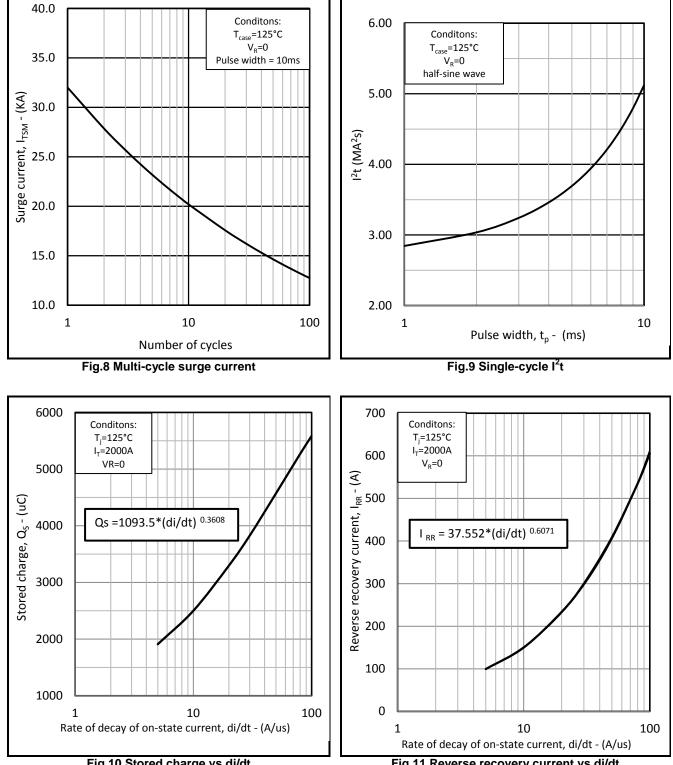


Fig.10 Stored charge vs di/dt

Fig.11 Reverse recovery current vs di/dt

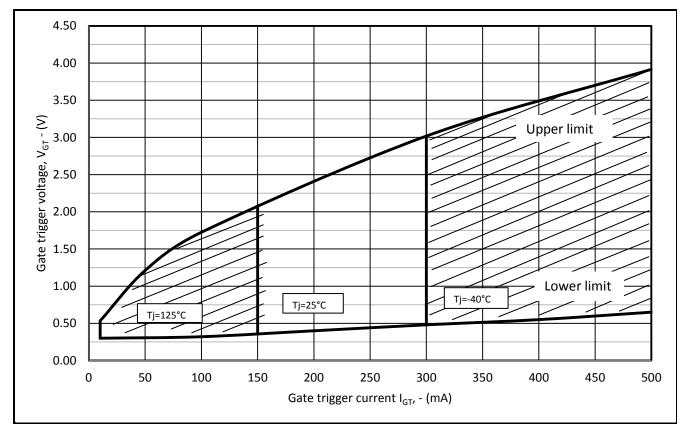


Fig.12 Gate characteristics

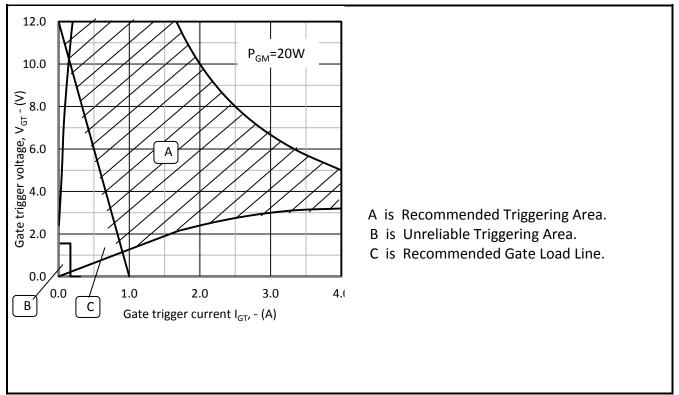


Fig.13 Gate characteristics

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PACKAGE DETAILS

For further package information, please contact Customer Services. All dimensions in mm, unless stated otherwise. DO NOT SCALE.

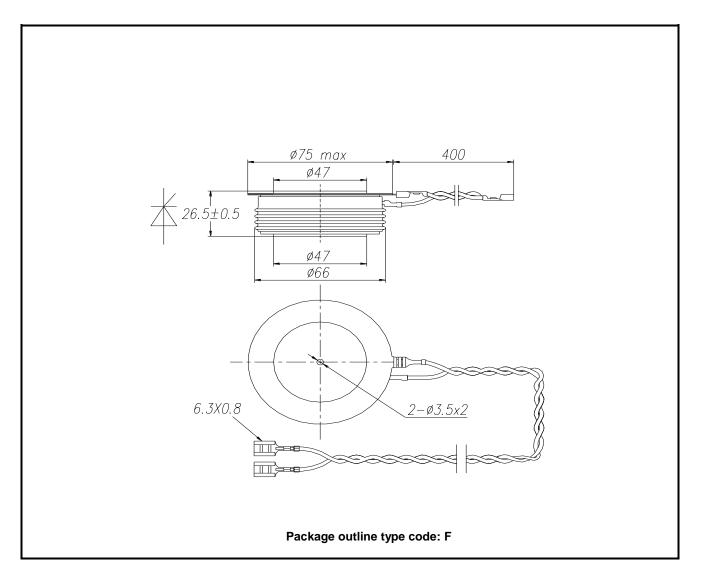


Fig.14 Package outline



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